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DISCRETE SEMICONDUCTORS

DATA SHEET

PDTA124E series

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

Product data sheet Supersedes data of 2003 Apr 14 2004 Aug 02



PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

FEATURES

- Built-in bias resistors
- · Simplified circuit design
- Reduction of component count
- · Reduced pick and place costs.

APPLICATIONS

- General purpose switching and amplification
- · Inverter and interface circuits
- Circuit driver.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V_{CEO}	collector-emitter voltage	_	-50	V
Io	output current (DC)	_	-100	mA
R1	bias resistor	22	_	kΩ
R2	bias resistor	22	_	kΩ

DESCRIPTION

PNP resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

PRODUCT OVERVIEW

TYPE NUMBER	PACI	KAGE	MARKING CODE	NDN COMPLEMENT	
TYPE NUMBER	PHILIPS	EIAJ	MARKING CODE	NPN COMPLEMENT	
PDTA124EE	SOT416	SC-75	05	PDTC124EE	
PDTA124EEF	SOT490	SC-89	3R	PDTC124EEF	
PDTA124EK	SOT346	SC-59	05	PDTC124EK	
PDTA124EM	SOT883	SC-101	DH	PDTC124EM	
PDTA124ES	SOT54 (TO-92)	SC-43	TA124E	PDTC124ES	
PDTA124ET	SOT23	_	*05 ⁽¹⁾	PDTC124ET	
PDTA124EU	SOT323	SC-70	*05 ⁽¹⁾	PDTC124EU	

Note

^{1. * =} p: Made in Hong Kong.

^{* =} t: Made in Malaysia.

^{* =} W: Made in China.

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL		PINNING
ITPE NUMBER	SIMPLIFIED OUTLINE AND STMBOL	PIN	DESCRIPTION
PDTA124ES	## Page 1	1 2 3	base collector emitter
PDTA124EE PDTA124EEF PDTA124EK PDTA124ET PDTA124EU	3 1 R1 1 R2 1 DD 2 Top view	1 2 3	base emitter collector
PDTA124EM	2 R1 3 Bottom view ADB267	1 2 3	base emitter collector

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-50	٧
V _{CEO}	collector-emitter voltage	open base	_	-50	٧
V _{EBO}	emitter-base voltage	open collector	_	-10	٧
VI	input voltage				
	positive		_	+10	٧
	negative		_	-40	٧
Io	output current (DC)		_	-100	mA
I _{CM}	peak collector current		-	-100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
	SOT54	note 1	_	500	mW
	SOT23	note 1	_	250	mW
	SOT346	note 1	_	250	mW
	SOT323	note 1	_	200	mW
	SOT416	note 1	_	150	mW
	SOT490	notes 1 and 2	_	250	mW
	SOT883	notes 2 and 3	_	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μ m copper strip line.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air		
	SOT54	note 1	250	K/W
	SOT23	note 1	500	K/W
	SOT346	note 1	500	K/W
	SOT323	note 1	625	K/W
	SOT416	note 1	833	K/W
	SOT490	notes 1 and 2	500	K/W
	SOT883	notes 2 and 3	500	K/W

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μ m copper strip line.

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0$	_	_	-100	nA
I _{CEO}	collector-emitter cut-off current	$V_{CE} = -30 \text{ V}; I_B = 0$	_	_	-1	μΑ
		$V_{CE} = -30 \text{ V}; I_B = 0; T_j = 150 \text{ °C}$	_	_	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	_	_	-180	μΑ
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V}; I_{C} = -5 \text{ mA}$	60	_	_	
V_{CEsat}	collector-emitter saturation voltage	$I_C = -10 \text{ mA}; I_B = -0.5 \text{ mA}$	_	_	-150	mV
$V_{i(off)}$	input-off voltage	$I_C = -100 \ \mu A; \ V_{CE} = -5 \ V$	_	-1.1	-0.8	V
$V_{i(on)}$	input-on voltage	$I_C = -5 \text{ mA}; V_{CE} = -0.3 \text{ V}$	-2.5	-1.7	_	V
R1	input resistor		15.4	22	28.6	kΩ
R2 R1	resistor ratio		0.8	1	1.2	
C _c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = -10 \text{ V}$; $f = 1 \text{ MHz}$	_	-	3	pF

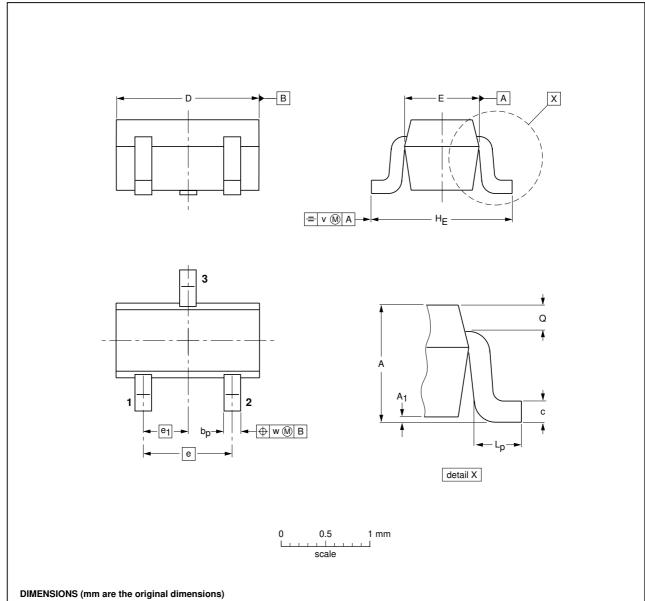
PNP resistor-equipped transistors; $R1 = 22 \text{ k}\Omega$, $R2 = 22 \text{ k}\Omega$

PDTA124E series

PACKAGE OUTLINES

Plastic surface-mounted package; 3 leads

SOT416



DIMENS	IONS (I	nm are	the origi	ınaı dim	ensions)	,
						_

UNIT	A	A ₁ max	bp	С	D	E	е	e ₁	HE	Lp	ø	v	w
mm	0.95 0.60	0.1	0.30 0.15	0.25 0.10	1.8 1.4	0.9 0.7	1	0.5	1.75 1.45	0.45 0.15	0.23 0.13	0.2	0.2

OUTLINE		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT416			SC-75		04-11-04 06-03-16

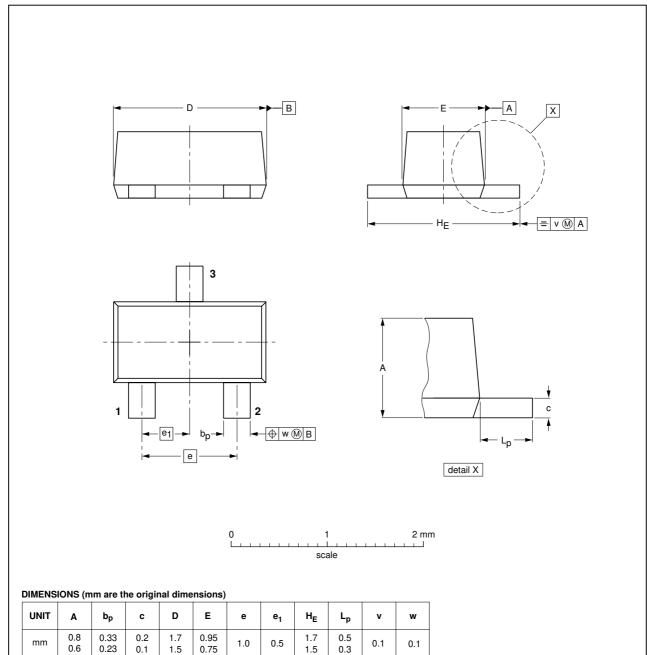
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PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

Plastic surface-mounted package; 3 leads

SOT490



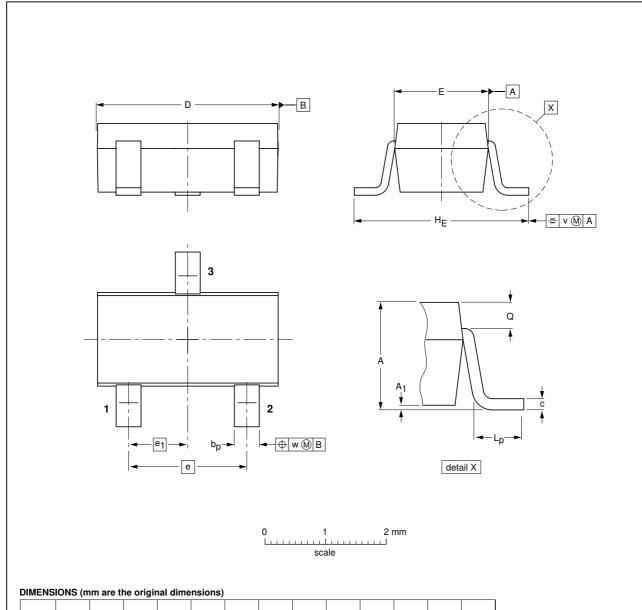
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	155UE DATE	
SOT490			SC-89		05-07-28 06-03-16	

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

Plastic surface-mounted package; 3 leads

SOT346



UNI	А	A ₁	bp	С	D	E	е	e ₁	HE	Lp	Q	v	w
mm	1.3 1.0	0.1 0.013	0.50 0.35	0.26 0.10	3.1 2.7	1.7 1.3	1.9	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2

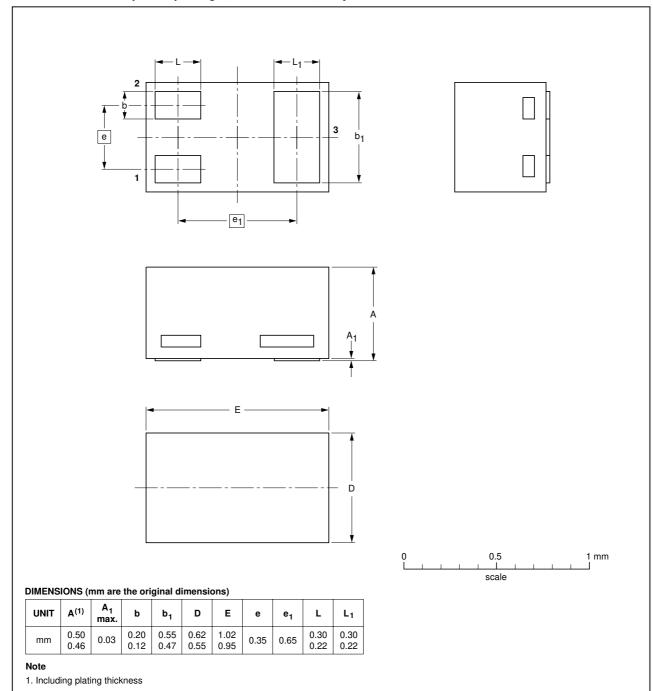
OUTLINE		REFER	EUROPEAN	IOOUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT346		TO-236	SC-59A			-04-11-11 06-03-16	

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

SOT883



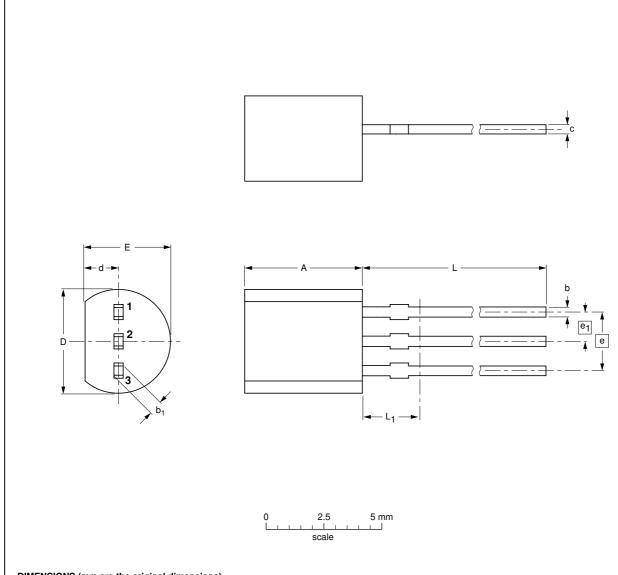
OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT883			SC-101		03-02-05 03-04-03

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



DIMENSIONS (mm are the original dimensions)

UNIT	Α	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

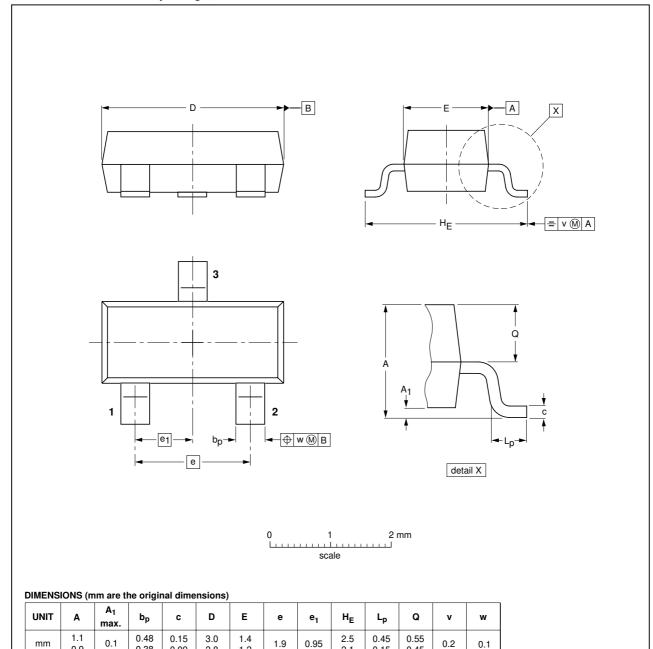
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT54		TO-92	SC-43A			-04-06-28 04-11-16

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

Plastic surface-mounted package; 3 leads

SOT23



OUTLINE		REFER	EUROPEAN	IOOUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT23		TO-236AB				-04-11-04- 06-03-16

2004 Aug 02 11

0.38

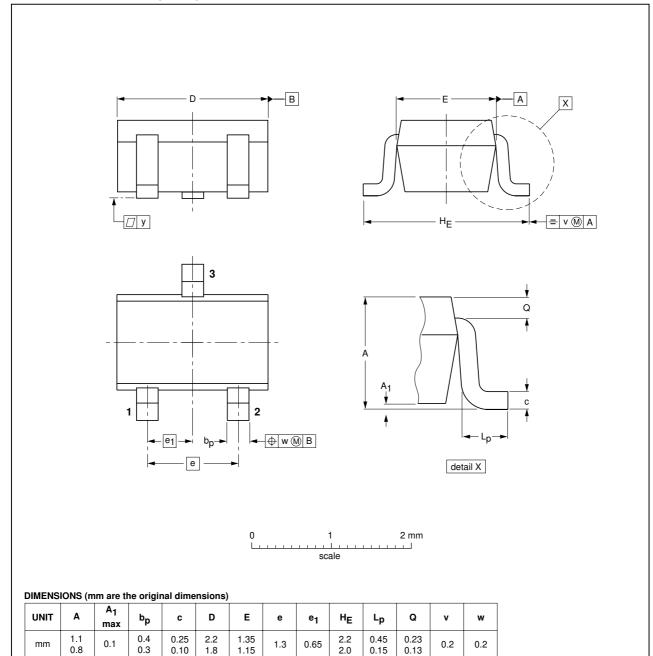
0.9

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

Plastic surface-mounted package; 3 leads

SOT323



OUTLINE			REFER	EUROPEAN	ISSUE DATE		
	VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	SOT323			SC-70			04-11-04 06-03-16
_						-	

PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 22 k Ω

PDTA124E series

DATA SHEET STATUS

DOCUMENT STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

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